





P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = 25°C
	75mΩ @ V _{GS} = -4.5V	-3.3A
-20V	140mΩ @ V _{GS} = -1.8V	-2.4A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Battery Charging
- Power Management Functions
- DC-DC Converters
- Portable Power Adaptors

Features and Benefits

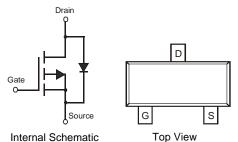
- Low On-Resistance
 - $75 \text{ m}\Omega$ @ $V_{GS} = -4.5V$
 - 96 m Ω @ V_{GS} = -2.5V
 - 140 mΩ @ V_{GS} = -1.8V
- Very Low Gate Threshold Voltage V_{GS(th)} ≤ 1V
- Low Input Capacitance
- · Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q 101 Standards for High Reliability

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.008 grams (approximate)







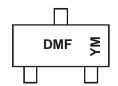
Ordering Information (Note 3)

Part Number	Case	Packaging
DMP2160U-7	SOT23	3000/Tape & Reel

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



DMF = Marking Code YM = Date Code Marking Y = Year (ex: V = 2008) M = Month (ex: 9 = September)

Date Code Key

- Date Code Itely												
Year	2008		2009	2010		2011	2012	!	2013	2014		2015
Code	V		W	Χ		Υ	Z		Α	В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units	
Drain-Source Voltage		V_{DSS}	-20	V
Gate-Source Voltage		V_{GSS}	±12	V
Continuous Drain Current (Note 4) V _{GS} = -4.5V	$T_A = 25$ °C $T_A = 70$ °C	I _D	-3.3 -2.6	А
Pulsed Drain Current		I _{DM}	-13	Α

Thermal Characteristics

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 4)	P_{D}	1.4	W
Thermal Resistance, Junction to Ambient	$R_{ hetaJA}$	90	°C/W
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	-55 to +150	°C

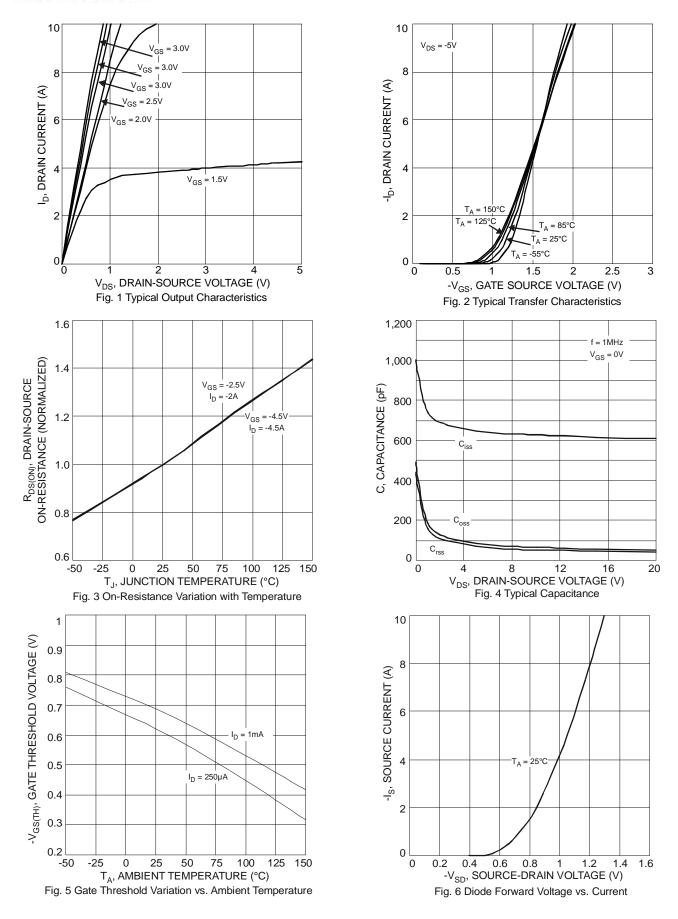
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20			V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}			-1.0	μΑ	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage		_	_	±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$
Gale-Source Leakage	I_{GSS}	_	_	±800	ΠA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 5)						
Gate Threshold Voltage	$V_{GS(th)}$	-0.4	-0.6	-0.9	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
			60	75		$V_{GS} = -4.5V, I_D = -1.5A$
Static Drain-Source On-Resistance	R _{DS (ON)}	_	73	96	mΩ	$V_{GS} = -2.5V, I_D = -1.2A$
	, ,		92	140		$V_{GS} = -1.8V, I_D = -1.2A$
Forward Transconductance	g _{FS}		7	_	S	$V_{DS} = -10V, I_{D} = -1.5A$
Diode Forward Voltage (Note 5)	V_{SD}	_	_	-1.0	V	$V_{GS} = 0V, I_{S} = -1.0A$
DYNAMIC CHARACTERISTICS (Note 6)	_			_		
Input Capacitance	C _{iss}		627	_	pF	V 40V V 0V
Output Capacitance	Coss	_	64	_	pF	$V_{DS} = -10V, V_{GS} = 0V$ -f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}		53	_	pF	1 = 1.0W112
Gate Resistance	R_G		44.9	_	Ω	$V_{GS} = 0V, V_{DS} = 0V, f = 1.0MHz$
Total Gate Charge	Q_g		6.5	_	nC	
Gate-Source Charge	Q_{gs}		0.9	_	nC	$V_{GS} = -4.5V$, $V_{DS} = -10V$, $I_{D} = -3A$
Gate-Drain Charge	Q_{gd}		1.5	_	nC	
Turn-On Delay Time	t _{D(on)}		12.5	_	ns	
Turn-On Rise Time	t _r		10.3		ns	$V_{DS} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(off)}	_	46.5	_	ns	$R_L = 10\Omega, R_G = 1.0\Omega, I_D = -1A$
Turn-Off Fall Time	t _f		22.2	_	ns	

Notes:

- 4. Device mounted on 1in^2 FR-4 PCB with 2 oz. Copper. $t \le 10$ sec.
- 5. Short duration pulse test used to minimize self-heating effect.6. Guaranteed by design. Not subject to product testing.







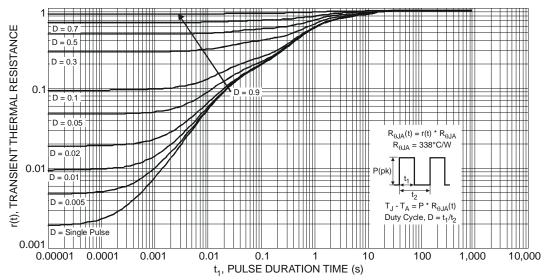
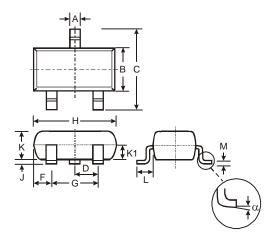


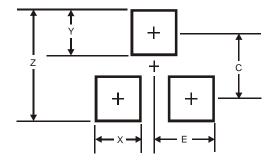
Fig. 7 Transient Thermal Response

Package Outline Dimensions



SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Η	2.80	3.00	2.90			
7	0.013	0.10	0.05			
K	0.903	1.10	1.00			
K1	-	-	0.400			
L	0.45	0.61	0.55			
М	0.085	0.18	0.11			
α	0°	8°	-			
All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Υ	0.9
C	2.0
E	1.35



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